MOSFETs Silicon N-Channel MOS (U-MOSVII-H)

TPC8223-H

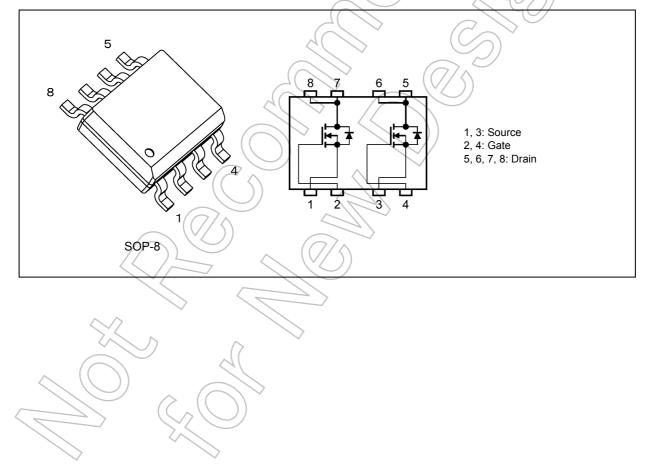
1. Applications

- High-Efficiency DC-DC Converters
- Notebook PCs
- Mobile Handsets

2. Features

- (1) Small, thin package
- (2) High-speed switching
- (3) Small gate charge: $Q_{SW} = 3.6 \text{ nC}$ (typ.)
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 17 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 4.5 \text{ V})$
- (5) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- (6) Enhancement mode: $V_{th} = 1.3$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 0.1$ mA)

3. Packaging and Internal Circuit



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4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	30	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)		(Note 1)	I _D	9	A
Drain current (pulsed)		(Note 1)	I _{DP}	36	
Power dissipation (single operation)	(t = 10 s)	(Note 2), (Note 4)	P _{D(1)}	1.5	W
Power dissipation (per device for dual operation)	(t = 10 s)	(Note 2), (Note 5)	P _{D(2)}	1.1	
Power dissipation (single operation)	(t = 10 s)	(Note 3), (Note 4)	P _{D(1)}	0.75	
Power dissipation (per device for dual operation)	(t = 10 s)	(Note 3), (Note 5)	P _{D(2)}	0.45	
Single-pulse avalanche energy		(Note 6)	EAS	52	mJ
Avalanche current			J _{AR}	9	A
Channel temperature		61	T _{ch}	150	°C
Storage temperature			◯ T _{stg}	-55 to 150	<u> </u>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics		Symbol	Max	Unit
Channel-to-ambient thermal resistance (single operation)	(t = 10 s) (Note 2), (Note 4)	R _{th(ch-a)(1)}	83.3	°C/W
Channel-to-ambient thermal resistance (per device for dual operation)	(t = 10 s) (Note 2), (Note 5)	R _{th(ch-a)(2)}	113	
Channel-to-ambient thermal resistance (single operation)	(t = 10 s) (Note 3), (Note 4)	R _{th(ch-a)(1)}	166	
Channel-to-ambient thermal resistance (per device for dual operation)	(t = 10 s) (Note 3), (Note 5)	R _{th(ch-a)(2)}	277	

Note 1: Ensure that the channel temperature does not exceed 150°C.

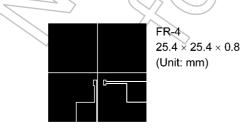
Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

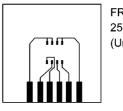
Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: Power dissipation and thermal resistance values per device with the other device being off (During single operation, power is supplied to only one of the two devices.)

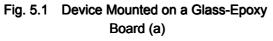
Note 5: Power dissipation and thermal resistance values per device for dual operation (During dual operation, power is evenly supplied to both devices.)

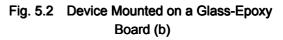
Note 6: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 1.2 Ω , I_{AR} = 9 A





FR-4 25.4 × 25.4 × 0.8 (Unit: mm)





Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

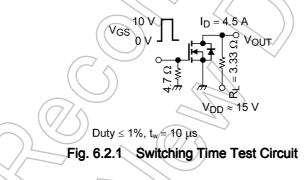
6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_	_	±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	\langle	_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	30		_	V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	15)~	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 0.1 mA	1.3	2_	2.3	
Drain-source on-resistance	R _{DS(ON)}	$V_{GS} = 4.5 V, I_D = 4.5 A$	$\langle A \rangle$	17	21	mΩ
		V _{GS} = 10 V, I _D = 4.5 A	9	14	17	

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		21190		pF
Reverse transfer capacitance	C _{rss}		((55	_	
Output capacitance	C _{oss}			210) —	
Gate resistance	r _g	V _{DS} = 10 V, V _{GS} = 0 V, f = 5 MHz	\sim	3.8	5.7	Ω
Switching time (rise time)	t _r	See Figure 6.2.1.		2.1	—	ns
Switching time (turn-on time)	t _{on}			7.9	—	
Switching time (fall time)	t _f			2.5	_	
Switching time (turn-off time)	t _{off}		<u> </u>	20	_	



6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Qg	$V_{DD} \approx 24$ V, V_{GS} = 10 V, I_D = 9 A		17	—	nC
gate-drain)		$V_{DD} \approx 24$ V, V_{GS} = 5 V, I_D = 9 A		8.3		
Gate-source charge 1	Q _{gs1}	$V_{DD} \approx 24$ V, V_{GS} = 10 V, I_D = 9 A		3.7	_	
Gate-drain charge	Q _{gd}		_	1.8	_	
Gate switch charge	Q _{SW}			3.6		

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

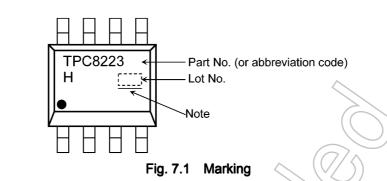
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 7)	I _{DRP}	—	_	_	36	А
Diode forward voltage	V _{DSF}	I _{DR} = 9 A, V _{GS} = 0 V		_	-1.2	V

Note 7: Ensure that the channel temperature does not exceed 150°C.

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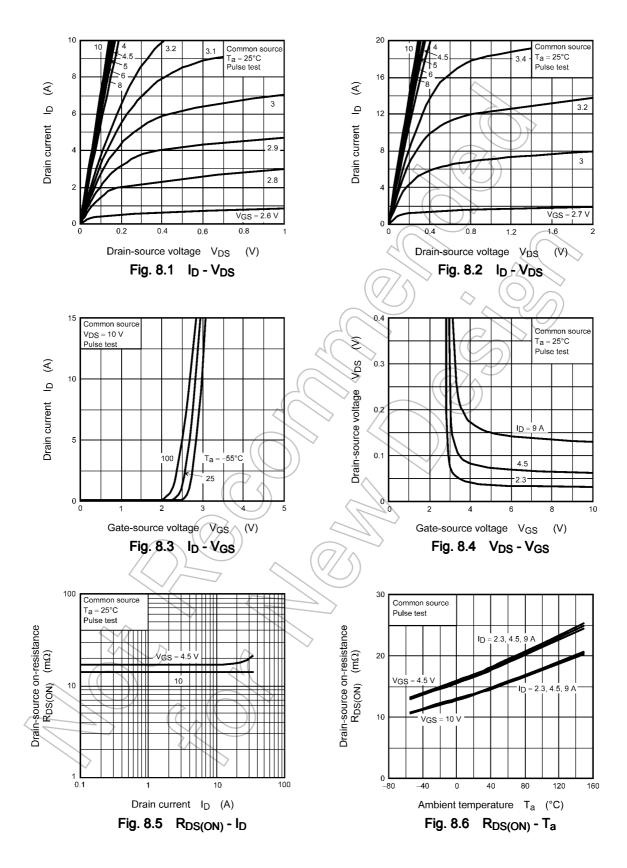
7. Marking (Note)

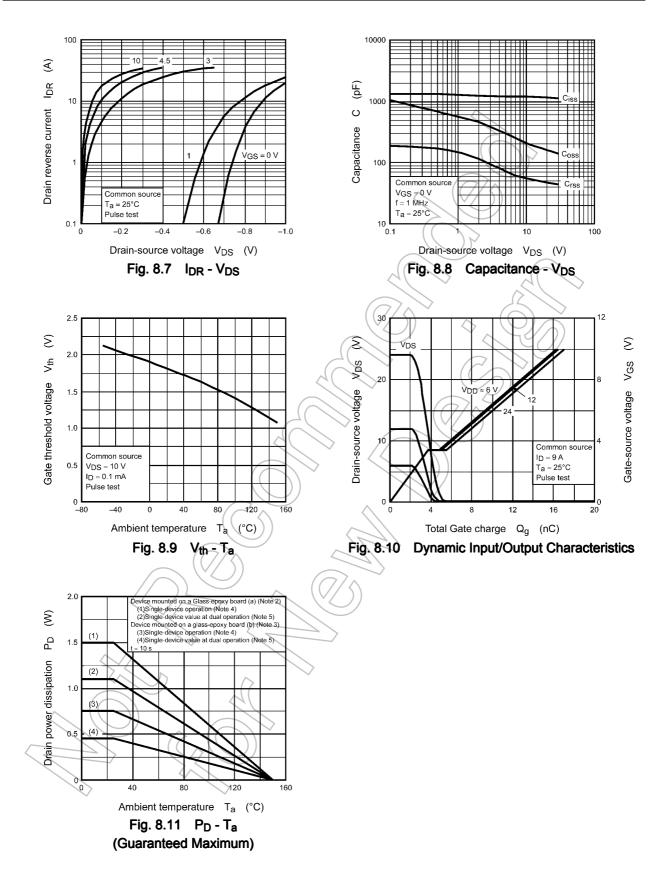


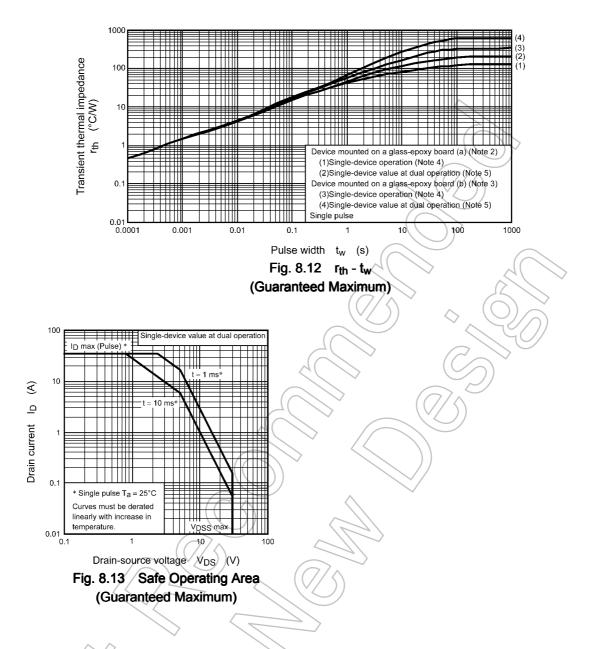
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8. Characteristics Curves (Note)





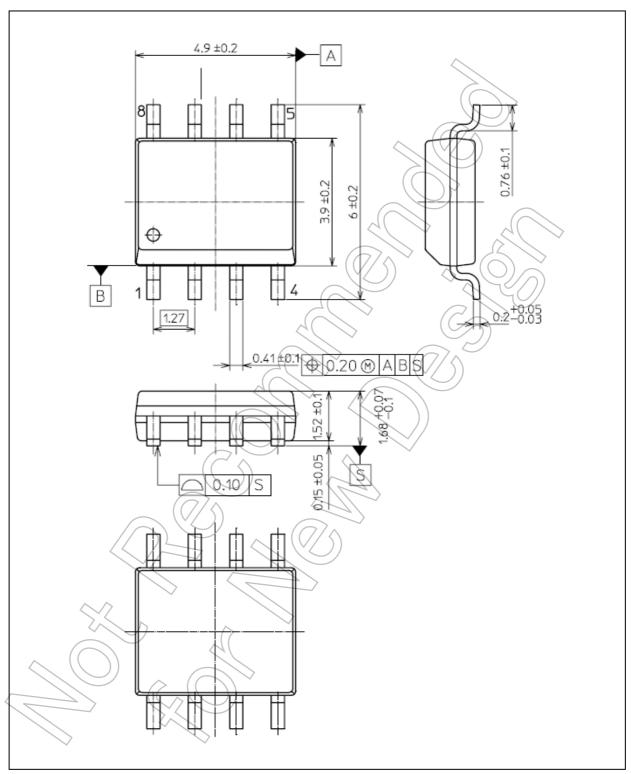


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.085 g (typ.)

Package Name(s)

TOSHIBA: 2-5R1S

Nickname: SOP-8

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